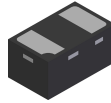


SURFACE MOUNT SCHOTTKY BARRIER DIODE
Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Low Capacitance
- Ultra-Small Surface Mount Package
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Dot
- Terminals: Finish — NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.001 grams (approximate)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	30	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	21	V
Maximum (Peak) Forward Current	I _{FM}	200	mA
Peak Forward Surge Current	I _{FSM}	1.0	A
		8.3ms Half Sine	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	250	mW
Thermal Resistance, Junction to Ambient Air	R _{θJA}	400	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 3)	V _{(BR)R}	30	—	—	V	I _R = 150μA
Forward Voltage Drop	V _F	—	—	350 575	mV	I _F = 20mA I _F = 200mA
Peak Reverse Current (Note 3)	I _R	—	—	150 30	μA μA	V _R = 30V V _R = 10V
Total Capacitance	C _T	—	20	—	pF	V _R = 0V, f = 1.0MHz

- Note: 1. No purposefully added lead.
 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 3. Short duration pulse test used to minimize self-heating effect.

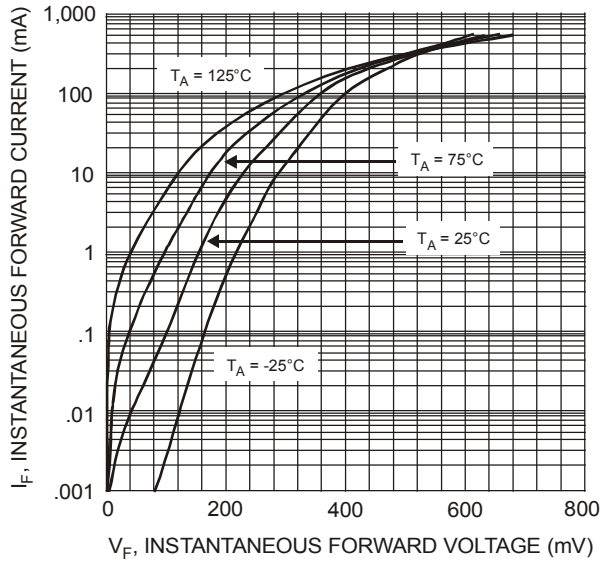


Fig. 1 Typical Forward Characteristics

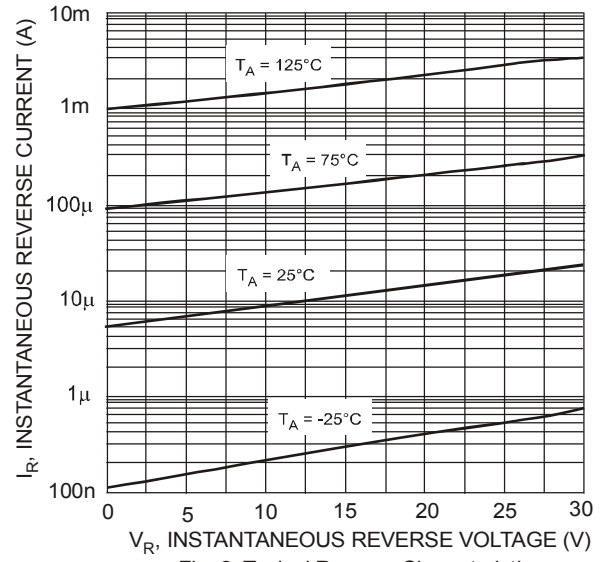


Fig. 2 Typical Reverse Characteristics

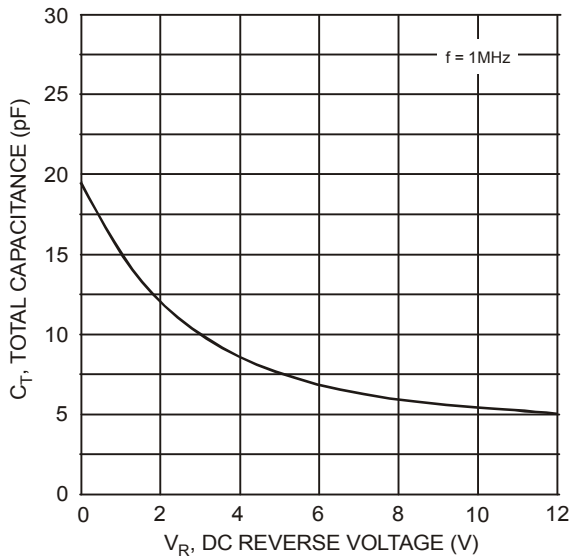


Fig. 3 Total Capacitance vs. Reverse Voltage

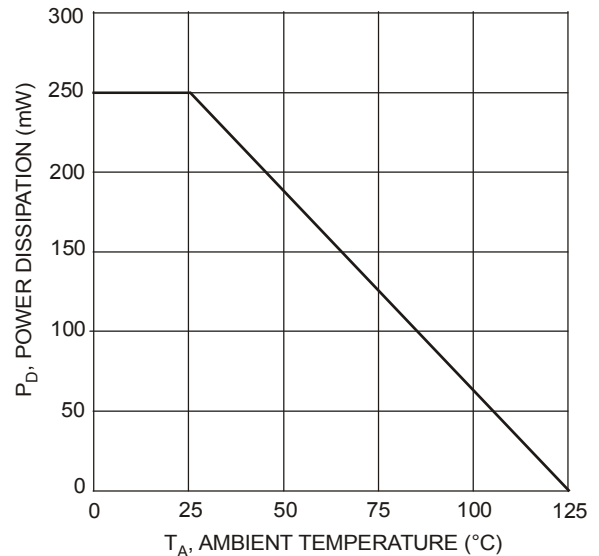


Fig. 4 Power Derating Curve

Ordering Information (Note 4)

Device	Packaging	Shipping
SDM20U30LP-7	DFN1006-2	3000/Tape & Reel

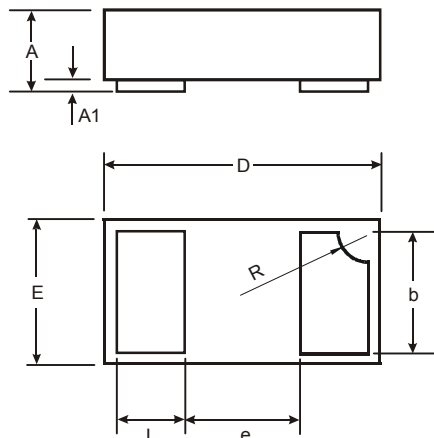
Notes: 4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information

• LM

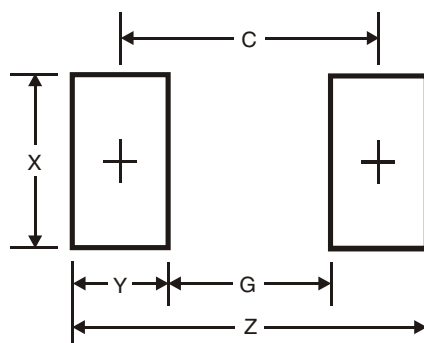
LM = Product Type Marking Code, Dot Denotes Cathode Side

Package Outline Dimensions



DFN1006-2			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	-	-	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
X	0.7
Y	0.4
C	0.7

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